

FOX WaferPak Contactor

Single Touchdown Full-Wafer Test & Burn-in



FOX WaferPak
Contactor

PRODUCT BENEFITS

- **Delivers FOX system resources to the wafer enabling single touchdown test and burn-in**
 - ◆ May be designed for up to 300 mm wafer sizes
 - ◆ Production proven with > 50,000 contacts per wafer
 - ◆ Pad Metallurgy: Al, Cu, Au or solder balls
 - ◆ Temperature range: Ambient to 150° C
- **Supports up to 2,048 I/O and DPS channels with remote voltage and ground sense per pin**
 - ◆ Handles up to 4 amps per contact
- **Handles up to 2 kW of power dissipation**
- **Enables high volume full wafer production test and burn-in with one touchdown**
- **Field repairable contactor**

“Setting the Test Standard for Tomorrow”

CORPORATE HEADQUARTERS

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